

550-10-360M19-001166

550-10-360M19-001166 Information

Heisener.com	Part Number Manufacturer Category Description Package	550-10-360M19-001166 Preci-Dip Connectors, Interconnects Sockets for ICs, Transistors BGA PIN ADAPTER 1.27MM SMD - For the pricing/inventory/lead time, please contact	
For Reference Only		us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



550-10-360M19-001166 Specifications

Manufacturer Part Number	550-10-360M19-001166
Manufacturer	Preci-Dip
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	550
Туре	BGA
Number of Positions or Pins (Grid)	360 (19 x 19)
Pitch - Mating	0.050" (1.27mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	10µin (0.25µm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Solder
Pitch - Post	0.050" (1.27mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	10µin (0.25µm)
Contact Material - Post	Brass
Housing Material	FR4 Epoxy Glass
Operating Temperature	-55°C ~ 125°C
	Report errors?

550-10-360M19-001166 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.



If you have any question about 550-10-360M19-001166, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com